

Key IoT Technologies: Unlocking the IoT Potential

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Abstracts

This report identifies the emerging IoT technologies.

For each of them, it also analyses their:

- Operating principle including advantages and drawbacks

- Drivers and barriers

- Adoption and related impacts for:

 - Verticals (both device manufacturers and end users)

 - Main IoT solution providers along the value chain

Finally, it also provides market estimates and forecasts in terms of annual shipments, for each technology at worldwide levels.

Contents

1. EXECUTIVE SUMMARY

2. METHODOLOGY & DEFINITIONS

- 2.1. General methodology of IDATE DigiWorld's reports
- 2.2. Market assessment and forecasts
- 2.3. Overall overview of main technologies

3. HARDWARE TECHNOLOGIES: EMBEDDED SIM

- 3.1. Operating principle
- 3.2. Pros and cons
- 3.3. Drivers and barriers
 - 3.3.1. Drivers
 - 3.3.2. Barriers
- 3.4. Vertical adoption
 - 3.4.1. Parts manufacturers
 - 3.4.2. End users
- 3.5. Main solution providers
 - 3.5.1. SIM card manufacturers
 - 3.5.2. Module manufacturers
 - 3.5.3. Telcos
 - 3.5.4. Platform providers and IT players

4. CONNECTIVITY TECHNOLOGIES

- 4.1. 6LoWPAN: pronounced "Six-Low-Pan"
 - 4.1.1. Operating principle
 - 4.1.2. Pros and cons
 - 4.1.3. Drivers and barriers
 - 4.1.4. Vertical adoption
 - 4.1.5. Major solution providers
- 4.2. LPWA
 - 4.2.1. Operating principle
 - 4.2.2. Pros and cons
 - 4.2.3. Drivers and barriers
 - 4.2.4. Vertical adoption

- 4.2.5. Main solution providers
- 4.3. Cellular IoT
 - 4.3.1. Technical description
 - 4.3.2. Pros and cons
 - 4.3.3. Drivers and barriers
 - 4.3.4. Vertical adoption
 - 4.3.5. Main solution providers

5. MIDDLEWARE TECHNOLOGIES

- 5.1. LwM2M/CoAP
 - 5.1.1. Operating principle
 - 5.1.2. Pros and cons
 - 5.1.3. Drivers and barriers
 - 5.1.4. Vertical adoption
 - 5.1.5. Main solution providers
- 5.2. MQTT
 - 5.2.1. Operating principle
 - 5.2.2. Pros and cons
 - 5.2.3. Drivers and barriers
 - 5.2.4. Vertical adoption
 - 5.2.5. Main solution providers

6. IT AND SOFTWARE TECHNOLOGIES: BIG DATA AND ANALYTICS

- 6.1. Operating principle
 - 6.1.1. Definition
 - 6.1.2. State of the art
 - 6.1.3. Perspective and future developments
- 6.2. Pros and cons
- 6.3. Drivers and barriers
- 6.4. Vertical adoption
 - 6.4.1. Main impacts
 - 6.4.2. Object manufacturers
 - 6.4.3. End Users
- 6.5. Main solution providers
 - 6.5.1. Module manufacturers
 - 6.5.2. Telcos
 - 6.5.3. IT players

7. MARKETS AND FORECASTS

7.1. Synthesis

7.2. Market development factors

7.2.1. Drivers

7.2.2. Barriers

7.3. Market forecasts

Tables

TABLES

- Table 1: Range and suitability of SIM cards
- Table 2: eUICC pros and cons
- Table 3: Drivers and barriers of eUICC
- Table 4: Adoption of eSIM technology, by verticals
- Table 5: Main properties of 802.15.4
- Table 6: 6LoWPAN pros and cons
- Table 7: Market drivers and barriers to 6LoWPAN
- Table 8: 6LoWPAN used in IPSO, Thread and ZigBee IP stacks
- Table 9: Application and levels of adoption of 6LoWPAN
- Table 10: Characteristics of LPWA
- Table 11: LPWA pros and cons
- Table 12: LPWA market drivers and barriers
- Table 13: Application and adoption rate of LPWA, by vertical
- Table 14: Players operating SIGFOX and LoRa
- Table 15: Partnerships between platform providers and LPWA providers
- Table 16: LTE-M and NB-IoT characteristics
- Table 17: Cellular, LTE-M and NB-IoT pros and cons
- Table 18: Cellular-based LPWA market drivers and barriers
- Table 19: CoAP/LwM2M pros and cons
- Table 20: LwM2M/CoAP market drivers and barriers
- Table 21: Implementation of LwM2M in IoT platforms
- Table 22: MQTT pros and cons
- Table 23: MQTT market drivers and barriers
- Table 24: Examples of industries and manufacturers having implemented MQTT
- Table 25: Implementation of MQTT in IoT platforms
- Table 26: Big data pros and cons
- Table 27: Drivers and barriers to big data
- Table 28: Vertical focus by IoT technology
- Table 29: Drivers and barriers to technology development

Figures

FIGURES

Figure 1: Key IoT technologies along the technical value chain

Figure 2: Introduction of a new role of subscription manager

Figure 3: Embedded SIM roadmap

Figure 4: eSIM for Samsung Gear S2 Classic 3G

Figure 5: Enjoying Internet connection on tablets without Wifi Hotspot

Figure 6: Major IoT industry players supporting the initiative

Figure 7: Audi connected car service dashboard illustration

Figure 8: Comparison of TCP/IP and 6LoWPAN protocol stacks

Figure 9: 6LoWPAN mesh network in an IPv6 network architecture

Figure 10: Use of 6LoWPAN in Thread

Figure 11: Use of 6LoWPAN in a version of ZigBee

Figure 12: Use of 6LoWPAN in environmental sensor network

Figure 13: Webtech wireless modules

Figure 14: IBM and Libelium development platform using IPv6

Figure 15: Integration of 6LoWPAN-based products

Figure 16: LPWA technologies mapping of RF technologies in terms of range and consumption

Figure 17: SIGFOX operating principle

Figure 18: LoRaWAN network architecture

Figure 19: SIGFOX ecosystem

Figure 20: Requirements of massive IoT networks and time-critical networks in the 5G specifications

Figure 21: Nine large operators officially supporting LTE-M

Figure 22: Comparison of OMA device management (DM) features and OMA Lightweight M2M

Figure 23: LwM2M architecture

Figure 24: CoAP operating principles

Figure 25: OpenAIS consortium

Figure 26: LwM2M/CoAP as part of Zebra Technologies IoT solution for better visibility of assets

Figure 27: Semiconductor company fiscal 2014 revenues and their link with LwM2M (green check)

Figure 28: LwM2M used in Gemalto SensorLogic platform

Figure 29: Integration of LwM2M in cellular architecture

Figure 30: LwM2M and NB-IoT cooperation

- Figure 31: MQTT: hub-and-spoke system
- Figure 32: Benefits of MQTT over HTTP
- Figure 33: Example of MQTT use
- Figure 34: QoS levels provided by MQTT
- Figure 35: Use cases for MQTT
- Figure 36: IBM Watson using MQTT
- Figure 37: Use of big-data analytics in manufacturing
- Figure 38: Data analytics on Intel production line
- Figure 39: Effects of servicisation on customer relationship
- Figure 40: Roadmap of different services offered by industrials
- Figure 41: Michelin Solutions architecture
- Figure 42: T-Mobile strategy towards the cloud and big data
- Figure 43: M2X service description
- Figure 44: Evolution of the annual shipments by technologies, worldwide
- Figure 45: Evolution of the big-data revenues from Internet of Things markets
- Figure 46: Shipments CAGR for each technology, 2017-2025, worldwide

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